

9-7-05

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Express Mail No. EV622661568US

Attorney Docket No. 108298404US2  
Disclosure No. 99-319.02/US**AMENDMENT TRANSMITTAL LETTER**Docket No.  
108298404US2Application No.  
10/772,541-Conf. #8900Filing Date  
February 5, 2004Examiner  
Y. T. TadesseArt Unit  
1734

Applicant(s): Agarwal et al.

Invention: METHOD AND APPARATUS FOR FORMING A PLANARIZING PAD FOR  
PLANARIZATION OF MICROELECTRONIC SUBSTRATES**TO THE COMMISSIONER FOR PATENTS**

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	17	- 20 =	0	x	
Independent Claims	4	- 3 =	1	x 200.00	200.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify): Extension for response within second month					450.00
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:</b>					<b>650.00</b>

☒ Large Entity☐ Small Entity☐ No additional fee is required for this amendment.☐ Please charge Deposit Account No. \_\_\_\_\_ in the amount of \$ \_\_\_\_\_.  
A duplicate copy of this sheet is enclosed.☒ A check in the amount of \$ 650.00 to cover the filing fee is enclosed.☐ Payment by credit card. Form PTO-2038 is attached.☒ The Director is hereby authorized to charge and credit Deposit Account No. 50-0665  
as described below.☒ Credit any overpayment.☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Dated: September 6, 2005

David T. Dutcher  
Attorney Reg. No.: 51,638PERKINS COIE LLP  
P.O. Box 1247  
Seattle, Washington 98111-1247  
(206) 359-8000



Express Mail No. EV622661568US

Attorney Docket No. 108298404US2  
Disclosure No. 99-0319.02/US

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: VISHNU K. AGARWAL AND  
DINESH CHOPRA

APPLICATION No.: 10/772,541

FILED: FEBRUARY 5, 2004

FOR: **APPARATUSES FOR FORMING A  
PLANARIZING PAD FOR  
PLANARIZATION OF  
MICROELECTRONIC SUBSTRATES**

EXAMINER: YEWEBDAR T.  
TADESSE

ART UNIT: 1734

CONF. No: 8900

**Amendment Under 37 C.F.R. § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated April 5, 2005 in the above-identified application. Please extend the period of time for response to this Office Action by two months, to expire September 5, 2005. Please amend the application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims beginning on page 3.

09/09/2005 MAHME1 00000049 10772541

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